



DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C			
00)/	$20.2m\Omega$ @ $V_{GS} = 4.5V$	21A			
20V	$23.5 \text{m}\Omega$ @ $V_{GS} = 2.5 \text{V}$	14A			

Features and Benefits

- Low Gate Threshold Voltage
- Low On-Resistance
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Battery Management Application
- Power Management Functions
- DC-DC Converters

U-DFN2030-6 (Type B)





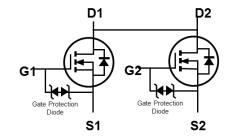
Bottom View

Mechanical Data

- Case: U-DFN2030-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (4)
- Weight: 0.012 grams (Approximate)







Equivalent Circuit

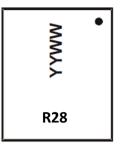
Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2024UFU-7	U-DFN2030-6 (Type B)	3000/Tape & Reel
DMN2024UFU-13	U-DFN2030-6 (Type B)	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



R28 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 20 for 2020) WW = Week Code (01 to 53)



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	20	V		
Gate-Source Voltage			V_{GSS}	±10	V
Continuous Drain Current (Note 6) \/ 45\/	Steady State	T _A = +25°C T _A = +70°C	l _D	7.5 6	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	$T_C = +25^{\circ}C$ $T_C = +70^{\circ}C$	lD	21 17	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	50	Α		
Maximum Continuous Body Diode Forward Current (Note 6)			Is	0.6	Α
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	12	Α		
Avalanche Energy (Note 7) L = 0.1mH	Eas	8	mJ		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	PD	0.81	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	155	°C/W	
Total Power Dissipation (Note 6)	T _A = +25°C	PD	1.71	W	
Thermal Resistance, Junction to Ambient (Note 6) Steady State		$R_{\theta JA}$	73	°C/W	
Thermal Resistance, Junction to Case (Note 6)	Steady State	Rejc	8.9	· C/vv	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

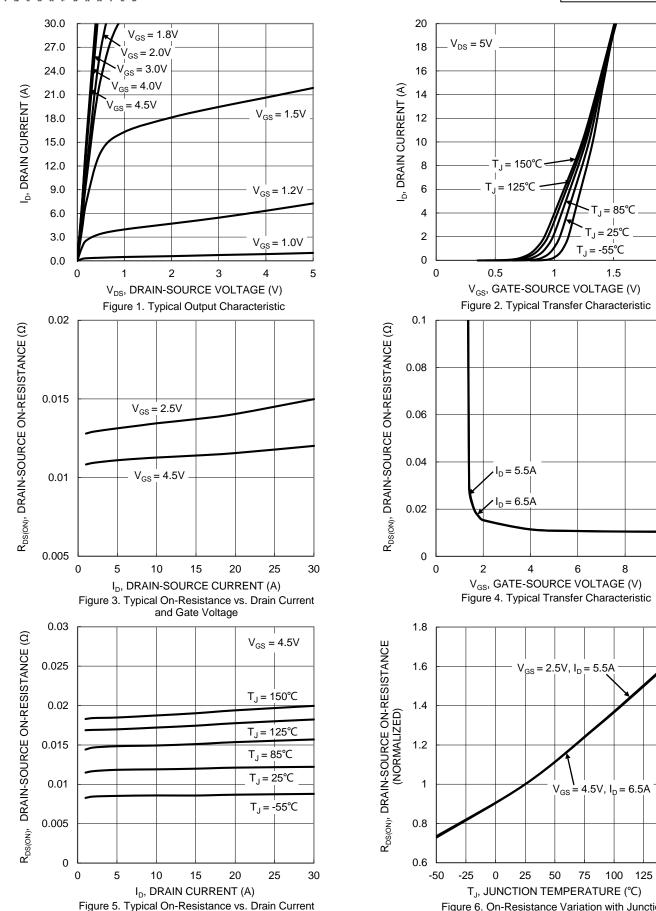
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current TJ = +25°C	IDSS	_	_	1	μA	V _{DS} = 20V, V _{GS} = 0V	
Gate-Source Leakage	Igss		_	±10	μA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	0.35	_	0.95	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}		11.2	20.2	mΩ	$V_{GS} = 4.5V, I_{D} = 6.5A$	
Static Drain-Source On-Resistance		_	13.2	23.5	mΩ	$V_{GS} = 2.5V, I_D = 5.5A$	
Diode Forward Voltage	VsD		0.7	1.0	V	V _G S = 0V, I _S = 1A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	647	_	pF	., ., ., ., ., ., ., ., ., ., ., ., ., .	
Output Capacitance	Coss	_	78	_	рF	V _{DS} = 10V, V _{GS} = 0V, -f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	38	_	pF	1 - 1.000112	
Gate Resistance	Rg	_	400	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (Vgs = 4.5V)	Q _G	-	6.5	_	nC		
Total Gate Charge (V _{GS} = 10V)	Q _G	-	14.8	_	nC	\/ 40\/ I- 0.5A	
Gate-Source Charge	Qgs	-	1.1	_	nC	$V_{DS} = 10V, I_{D} = 6.5A$	
Gate-Drain Charge	Q_{GD}	-	1.7	_	nC	1	
Turn-On Delay Time	td(ON)	-	140	_	ns		
Turn-On Rise Time	tR		1024	_	ns	V _{DS} = 10V, V _{GS} = 4.5V,	
Turn-Off Delay Time	t _{D(OFF)}		434	_	ns	$R_G = 6\Omega$, $R_L = 10\Omega$, $I_D = 1A$	
Turn-Off Fall Time	tF	_	245	_	ns	1	
Reverse Recovery Time	trr	_	149	_	ns	1 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	
Reverse Recovery Charge	Q _{RR}		647	_	nC	I _F = 1A, di/dt = 100A/μs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

- I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.





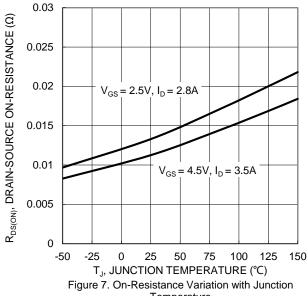
and Junction Temperature

Figure 6. On-Resistance Variation with Junction

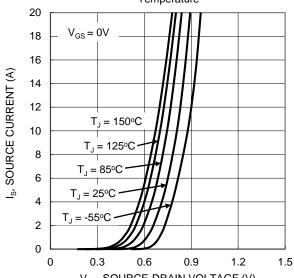
Temperature

10





Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

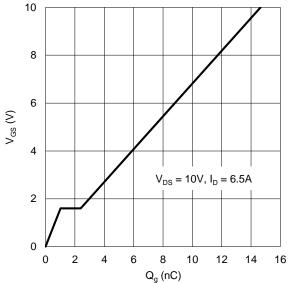


Figure 11. Gate Charge

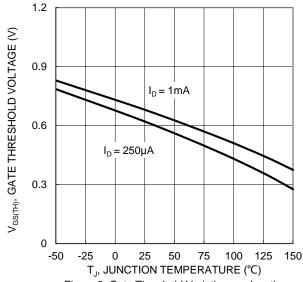


Figure 8. Gate Threshold Variation vs. Junction Temperature

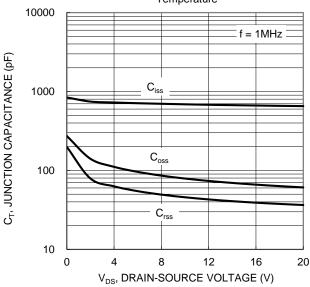


Figure 10. Typical Junction Capacitance

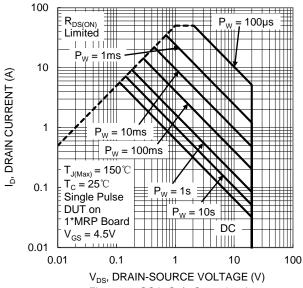


Figure 12. SOA, Safe Operation Area



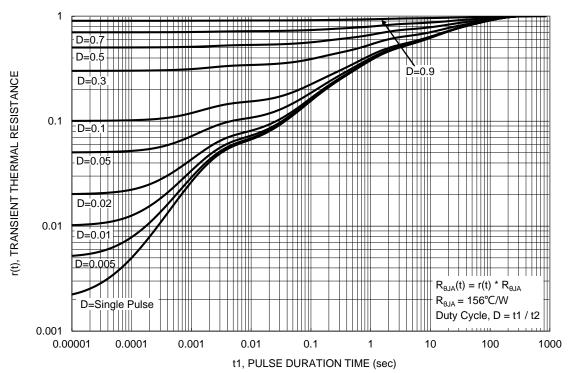


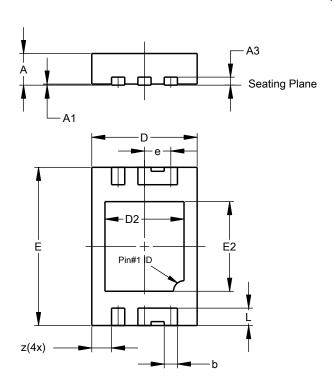
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2030-6 (Type B)

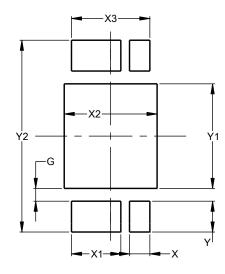


U-DFN2030-6 (Type B)					
Dim	Min	Max	Тур		
Α	0.55	0.65	0.60		
A1	0.00	0.05	0.02		
A3	-		0.15		
b	0.20	0.30	0.25		
D	1.95	2.05	2.00		
D2	1.40	1.60	1.50		
Е	2.95	3.05	3.00		
E2	1.65	1.75	1.70		
е	-		0.50		
L	0.28	0.38	0.33		
Z	-		0.375		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2030-6 (Type B)



Dimensions	Value		
Dilliensions	(in mm)		
G	0.220		
X	0.350		
X1	0.850		
X2	1.600		
Х3	1.350		
Y	0.530		
Y1	1.800		
Y2	3.300		



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